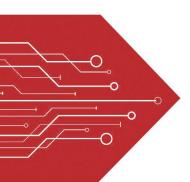
MSKSEMI















ESD

TVS

TSS

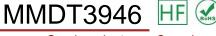
MOV

GDT

PLED

Broduct data sheet



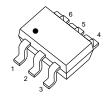












SOT-363

MAKING: K46 ·

MMDT3946

DUAL TRANSISTOR (NPN+PNP)

FEATURES

- Complementary Pair
- One 3904-Type NPN One 3906-Type PNP
- **Epitaxial Planar Die Construction**
- Ideal for Low Power Amplification and Switching

MAXIMUM RATINGS (T_a=25℃ unless otherwise noted)

Symbol	Parameter	Value	Units
V _{CBO}	Collector-Base Voltage	60	V
V _{CEO}	Collector-Emitter Voltage	40	V
V _{EBO}	Emitter-Base Voltage	5	V
Ic	Collector Current -Continuous	0.2	Α
Pc	Collector Power Dissipation	0.2	W
TJ	Junction Temperature	150	$^{\circ}\!\mathbb{C}$
T _{stg}	Storage Temperature	-55-150	$^{\circ}\!\mathbb{C}$

NPN 3904 ELECTRICAL CHARACTERISTICS (Ta=25℃ unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Max	Unit
Collector-base breakdown voltage	own voltage $V_{(BR)CBO}$ $I_C = 10\mu A$, $I_E=0$		60		V
Collector-emitter breakdown voltage	V _{(BR)CEO}	I _C = 1mA, I _B =0	40		V
Emitter-base breakdown voltage	V _{(BR)EBO}	I _E = 10μA, I _C =0	5		V
Collector cut-off current	I _{CBO}	V _{CB} = 30 V , I _E =0		0.05	μA
Collector cut-off current	I _{CEO}	V _{CE} = 30 V , I _B =0		0.5	μA
Emitter cut-off current	I _{EBO}	V _{EB} = 5V , I _C =0		0.05	μΑ
	h _{FE(1)}	V _{CE} = 1V, I _C = 0.1mA	40		
	h _{FE(2)}	V _{CE} = 1V, I _C = 1mA	70		
DC current gain	h _{FE(3)}	V _{CE} = 1V, I _C = 10mA	100	300	
	h _{FE(4)}	V _{CE} = 1V, I _C = 50mA	60		
	h _{FE(5)}	V _{CE} = 1V, I _C = 100mA	30		
Collector-emitter saturation voltage	V _{CE(sat)1}	I _C =10 mA, I _B = 1mA		0.2	V
Collector-enlitter Saturation voltage	V _{CE(sat)2}	I _C =50 mA, I _B = 5mA		0.3	V
Base-emitter saturation voltage	V _{BE(sat)1}	I _C = 10 mA, I _B = 1mA	0.65	0.85	V
Base-emitter saturation voitage	V _{BE(sat)2}	I _C = 50 mA, I _B = 5mA		0.95	V
Transition frequency	f⊤	V _{CE} =20V,I _C =20mA, f=100MHz	300		MHz
Noise figure	NF	V_{CE} =5V, I_c =0.1mA, f=1KHz,Rg=1K Ω		5	dB
Output capacitance	C _{ob}	V _{CB} =5V,I _E =0,f=1MHz		4	pF
Delay time	t _d	V _{CC} =3V, V _{BE} =0.5V		35	nS
Rise time	t _r	I _C =10mA , I _{B1} =- I _{B2} =1mA		35	nS
Storage time	ts V _{CC} =3V, I _C =10mA			200	nS
Fall time	t _f	I _{B1} =-I _{B2} = 1mA		50	nS

MAXIMUM RATINGS(T_a=25°C unless otherwise noted)

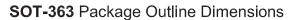
Symbol	Parameter	Value	Units	
V _{CBO}	Collector-Base Voltage	-40	V	
V _{CEO}	Collector-Emitter Voltage	-40	V	
V _{EBO}	Emitter-Base Voltage	-5	V	
Ic	Collector Current -Continuous	-0.2	А	
Pc	Collector Power Dissipation	0.2	W	
TJ	Junction Temperature	150	°C	
T _{stg}	Storage Temperature	-55-150	℃	

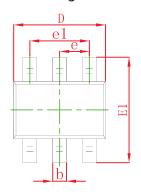
PNP 3906 ELECTRICAL CHARACTERISTICS (Ta=25°C unless otherwise specified)

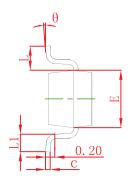
Parameter	Symbol	Test conditions	Min	Тур	Max	Unit
Collector-base breakdown voltage	V _{(BR)CBO}	I _C =-10μΑ,I _E =0	-40			V
Collector-emitter breakdown voltage	V _{(BR)CEO}	I _C =-1mA,I _B =0	-40			V
Emitter-base breakdown voltage	V _{(BR)EBO}	I _E =-10μΑ,I _C =0	-5			V
Collector cut-off current	I _{CBO}	V _{CB} =-30V,I _E =0			-0.05	μA
Emitter cut-off current	I _{EBO}	V _{EB} =-5V,I _C =0			-0.05	μA
	h _{FE(1)}	V _{CE} =-1V,I _C =-0.1mA	60			
	h _{FE(2)}	V _{CE} =-1V,I _C =-1mA	80			
DC current gain	h _{FE(3)}	V _{CE} =-1V,I _C =-10mA	100		300	
	h _{FE(4)}	V _{CE} =-1V,I _C =-50mA	60			
	h _{FE(5)}	V _{CE} =-1V,I _C =-100mA	30			
0-11-4	V _{CE(sat)1}	I _C =-10mA,I _B =-1mA			-0.25	V
Collector-emitter saturation voltage	V _{CE(sat)2}	I _C =-50mA,I _B =-5mA			-0.4	V
Page emitter acturation voltage	V _{BE(sat)1}	I _C =-10mA,I _B =-1mA	-0.65		-0.85	V
Base-emitter saturation voltage	V _{BE(sat)2}	I _C =-50mA,I _B =-5mA			-0.95	V
Transition frequency	f _T	V _{CE} =-20V,I _C =-10mA,f=100MHz	250			MHz
Collector output capacitance	C _{ob}	V _{CB} =-5V,I _E =0,f=1MHz			4.5	pF
Noise figure	NF	V_{CE} =-5V, I_{c} =-0.1mA, f=1KHz,Rg=1K Ω			4	dB
Delay time	t _d	V _{CC} =-3V, V _{BE} =-0.5V			35	nS
Rise time	t _r	I _C =-10mA , I _{B1} =-I _{B2} =-1mA			35	nS
Storage time	ts	V _{CC} =-3V, I _C =-10mA			225	nS
Fall time	t _f	I _{B1} =-I _{B2} =- 1mA			75	nS

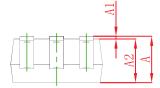






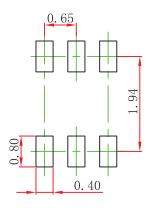






Symbol	Dimensions In Millimeters		Dimensions In Inches	
Symbol	Min	Max	Min	Max
Α	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
С	0.100	0.150	0.004	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.400	0.085	0.094
е	0.650 TYP		0.026	S TYP
e1	1.200	1.400	0.047	0.055
L	0.525 REF		0.021	REF
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

SOT-363 Suggested Pad Layout



Note:

- 1.Controlling dimension:in millimeters. 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
MMDT3946	SOT-363	3000



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